

P-Channel Enhancement MOSFET

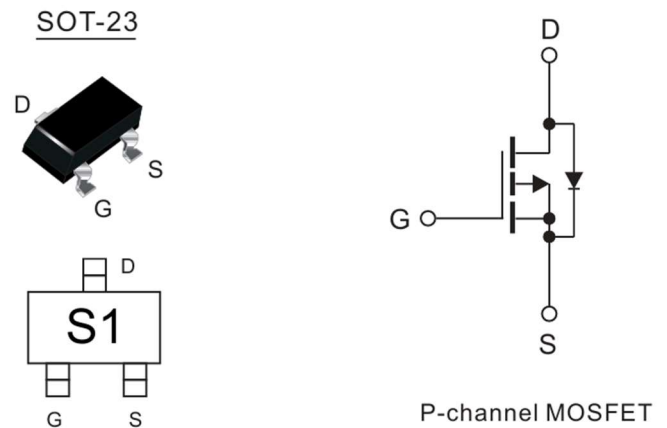
Features

- TrenchFET Power MOSFET
- Halogen-Free & Lead-Free

| Product Summary | | | |
|-----------------|--------------------------------|-----------|-------------|
| V_{DS} | $R_{DS(on)}$ (m Ω) Typ | I_D (A) | Q_g (Typ) |
| -20V | 89 @ -2.5V | -2 | 3.3nc |
| | 64 @ -4.5V | -3 | |

Application

- Load Switch for Portable Devices
- Voltage controlled small signal switch



Absolute Maximum Ratings (at $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|----------------|----------|------------------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | V |
| Continuous Drain Current | I_D | -2.3 | A |
| Power Dissipation | P_D | 1 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55~150 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Max. | Unit |
|---|-----------------|------|--------------------|
| Thermal Resistance from Junction to Ambient ¹⁾ | $R_{\theta JA}$ | 104 | $^\circ\text{C/W}$ |

Note:

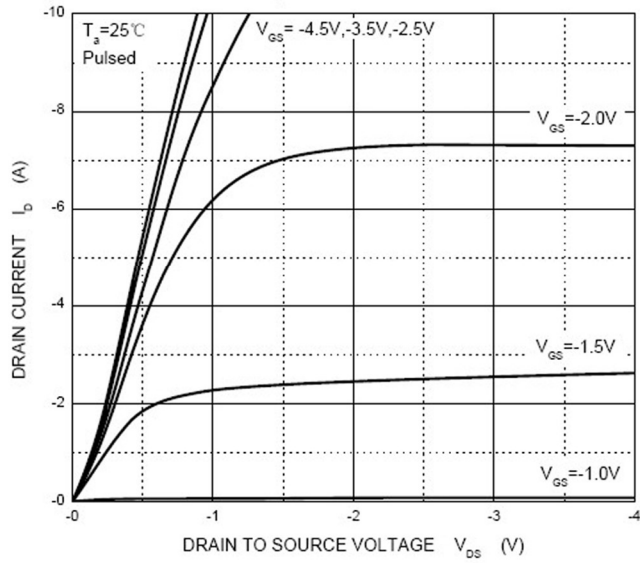
1) Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

Characteristics at T_J = 25°C unless otherwise specified

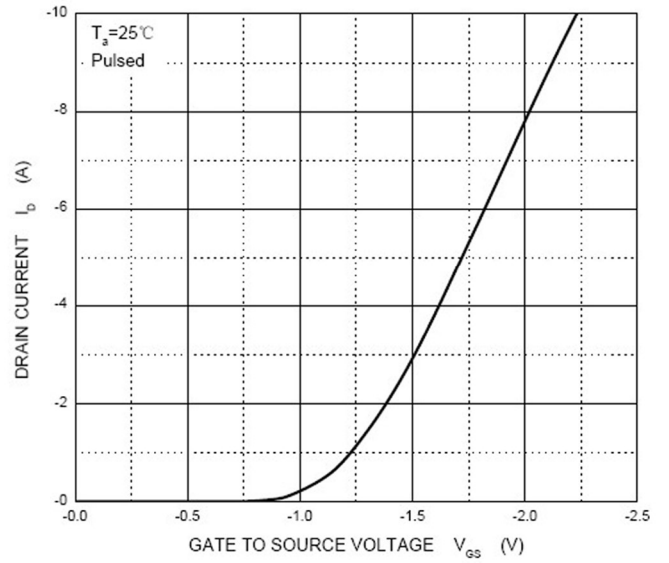
| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|--|---------------------|------|----------|------------|------|
| STATIC PARAMETERS | | | | | |
| Drain-Source Breakdown Voltage at V _{GS} =0V, I _D =-250μA | BV _{DSS} | -20 | | | V |
| Drain-Source Leakage Current at V _{DS} =-20V, V _{GS} =0V | I _{DSS} | | | -1 | μA |
| Gate Leakage Current at V _{GS} =±12V, V _{DS} =0V | I _{GSS} | | | ±0.1 | μA |
| Gate-Source Threshold Voltage at V _{DS} =V _{GS} , I _D =-250μA | V _{GS(th)} | -0.4 | -0.7 | -1.0 | V |
| Drain-Source On-State Resistance at V _{GS} = -4.5V, I _D = -3A at V _{GS} = -2.5V, I _D = -2A | R _{DS(on)} | | 64 89 | 110 140 | mΩ |
| DYNAMIC PARAMETERS | | | | | |
| Input Capacitance at V _{GS} =0V, V _{DS} =-10V, f=1MHz | C _{iss} | | 405 | | pF |
| Output Capacitance at V _{GS} =0V, V _{DS} =-10V, f=1MHz | C _{oss} | | 75 | | |
| Reverse Transfer Capacitance at V _{GS} =0V, V _{DS} =-10V, f=1MHz | C _{rss} | | 55 | | |
| Gate charge total at V _{DS} =-10V, V _{GS} =-2.5V, I _D =-3A | Q _g | | 3.3 | | nC |
| Gate to Source Charge at V _{DS} =-10V, V _{GS} =-2.5V, I _D =-3A | Q _{gs} | | 0.7 | | |
| Gate to Drain Charge at V _{DS} =-10V, V _{GS} =-2.5V, I _D =-3A | Q _{gd} | | 1.3 | | |
| Turn-On Delay Time at V _{DD} =-10V, V _{GS} =-4.5V, R _{GEN} =10Ω, I _D =-1A | t _{d(on)} | | 11 | | nS |
| Turn-On Rise Time at V _{DD} =-10V, V _{GS} =-4.5V, R _{GEN} =10Ω, I _D =-1A | t _r | | 35 | | |
| Turn-Off Delay Time at V _{DD} =-10V, V _{GS} =-4.5V, R _{GEN} =10Ω, I _D =-1A | t _{d(off)} | | 30 | | |
| Turn-Off Fall Time at V _{DD} =-10V, V _{GS} =-4.5V, R _{GEN} =10Ω, I _D =-1A | t _f | | 10 | | |
| Body-Diode PARAMETERS | | | | | |
| Drain-Source Diode Forward Voltage at I _S =-1.3A, V _{GS} =0V | V _{SD} | | | -1.2 | V |
| Maximum Body-Diode Continuous Current | I _S | | | -1.3 | A |

Electrical Characteristics Curves

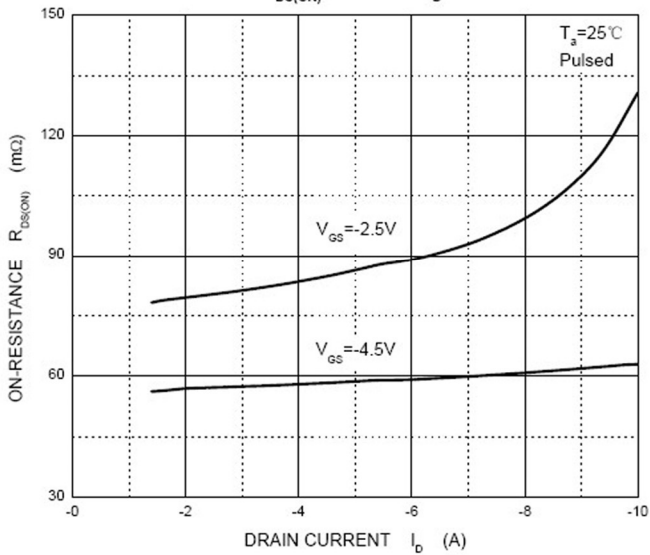
Output Characteristics



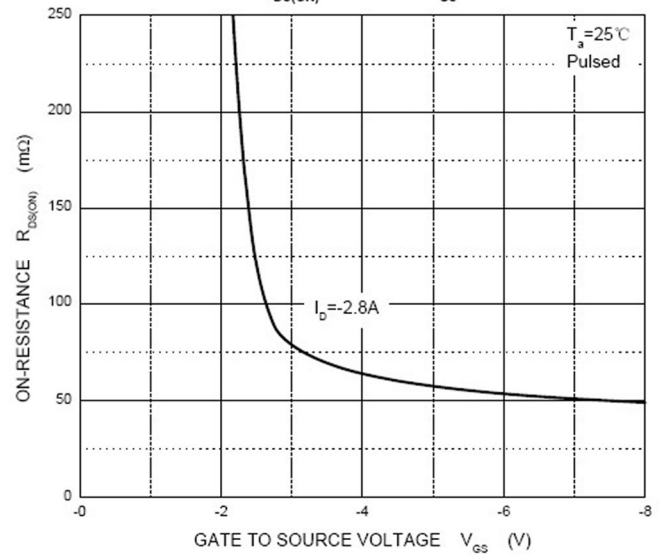
Transfer Characteristics



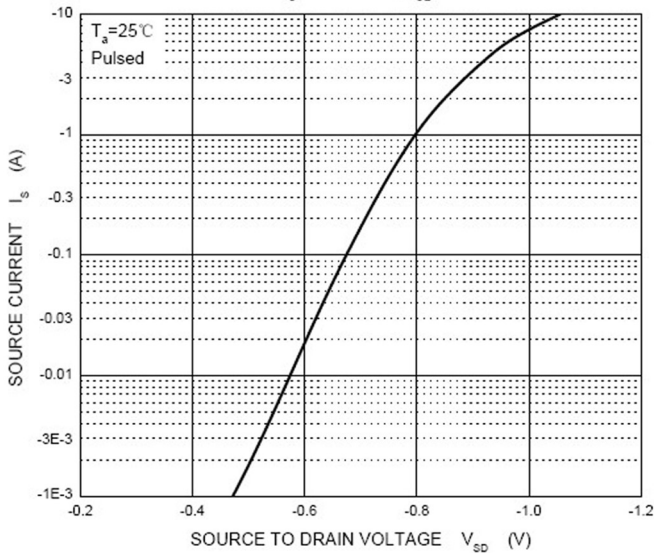
$R_{DS(ON)}$ — I_D



$R_{DS(ON)}$ — V_{GS}



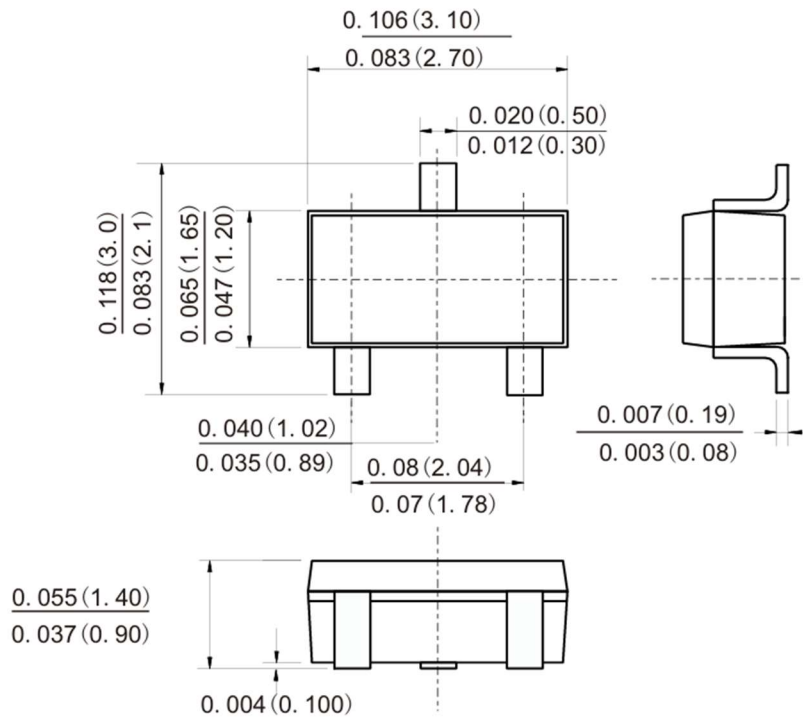
I_S — V_{SD}



Order Information

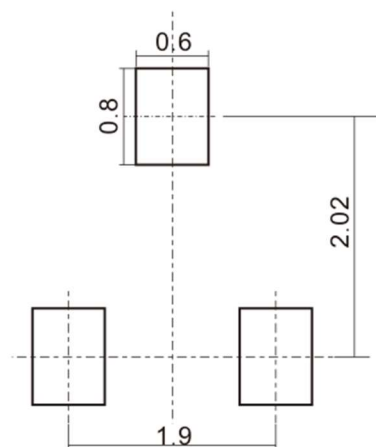
| Part Number | Package | Quantity |
|-------------|---------|----------|
| Sh2301 | SOT-23 | 3000 |

Package Outline Dimensions (Units: mm) SOT-23



Dimensions in inches and (millimeters)

Suggested Pad Layout



Dimensions in millimeters